ABSTRACT OF THE DISCLOSURE

includes diode lateral conduction Schottky Α multiple mesa regions upon which Schottky contacts are formed and which are at least separated by ohmic contacts to reduce the current path length and reduce current crowding in the Schottky contact, thereby reducing the forward resistance of a The multiple mesas may be isolated from one another and have sizes and shapes optimized for reducing the forward may some of the mesas Alternatively, resistance. finger-shaped and intersect with a central mesa or a bridge mesa, and some or all of the ohmic contacts are interdigitated with the finger-shaped mesas. The dimensions of the fingershaped mesas and the perimeter of the intersecting structure may be optimized to reduce the forward resistance. Schottky diodes may be mounted to a submount in a flip chip arrangement that further reduces the forward voltage as well as improves power dissertation and reduces heat generation.

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